

# **RA8835**

## Dot Matrix LCD Controller Specification

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### 1. Overview

The RA8835 is a controller IC that can display text and graphics on LCD panel. It can display layered text and graphics, scroll the display in any direction and partition the display into multiple screens. It also stores text, character codes and bitmapped graphics data in external frame buffer memory. Display controller functions include transferring data from the controlling microprocessor to the buffer memory, reading memory data, converting data to display pixels and generating timing signals for the buffer memory, LCD panel.

The RA8835 has an internal character generator with 160, 5 X 7 pixel characters in internal mask ROM. The character generators support up to 64, 8 X 16 pixel characters in external character generator RAM and up to 256, 8 X 16 pixel characters in external character generator ROM.

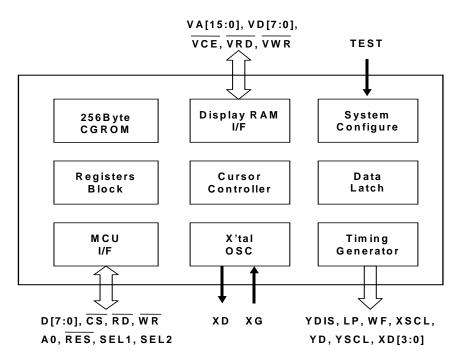
#### 2. Features

- Text, graphics and combined text/graphics display modes
- Three overlapping screens in graphics mode
- Up to 640 X 256 pixel LCD panel display resolution
- Programmable cursor control
- Smooth horizontal and vertical scrolling of all or part of the display
- ◆ 1/2-duty to 1/256-duty LCD drive
- Up to 640 X 256 pixel LCD panel display resolution memory
- 160, 5 X 7 pixel characters in internal mask-

programmed character generator ROM

- Up to 64, 8 X 16 pixel characters in external character generator RAM
- Up to 256, 8 X 16 pixel characters in external character generator ROM
- ♦ 6800 and 8080 family microprocessor interfaces
- ♦ Low power consumption—3.5 mA operating current (V<sub>DD</sub> = 3.5V), 0.05 µA standby current
- Package: RA8835P3N: QFP-60 pin (Lead Free) RA8835P4N: TQFP-60 pin (Lead Free)
- Power: 2.7 to 5.5 V

## 3. Block Diagram



### 4. Package

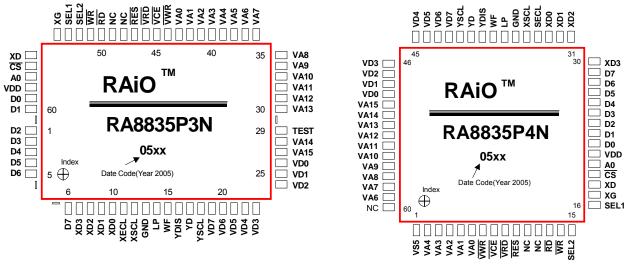




Figure 4-2: RA8835P4N (TQFP-60 Pin)

## 5. Pin Descriptions

#### 5.1.1. MCU Interface

t pins. Connect t	hese nins t			
MCU Data Bus. Tri-state input/output pins. Connect these pins to an 8- or 16-bit microprocessor bus.				
		•		e 8085 and
". Interface	A0	RD	WR	CS
8080 family	A0	RD	WR	CS
6800 family	A0	E	R/W	CS
		•		
hily interface is s A8835 series out hily interface is se	put buffers	are enable s signal ac	ed when thi ts as the ac	is signal is ctive-HIGH
	supports both 80 nily processors (s 2* Interface 8080 family 6800 family ed directly to VE ecouple it to grou nable. nily interface is s A8835 series out	supports both 8080 family p   nily processors (such as the   2* Interface   A0   6800 A0   family A0   6800 A0   family A0   ed directly to VDD or VSS   ecouple it to ground using a   nable.   nily interface is selected, thi   A8835 series output buffers   nily interface is selected, this	supports both 8080 family processors (   nily processors (such as the 6802 and 6   2* Interface A0 RD   2* 8080 A0 RD   6800 A0 RD   6800 A0 E   ed directly to VDD or VSS to prevent   ecouple it to ground using a capacitor p   nable.   nily interface is selected, this signal ac   A8835 series output buffers are enable   nily interface is selected, this signal ac	supports both 8080 family processors (such as the 6802 and 6809). $2^*$ InterfaceA0 $\overline{RD}$ $\overline{WR}$ $2^*$ $\overline{RD}$ $\overline{RD}$ $\overline{WR}$ $\overline{R}$ $\overline{RD}$ $\overline{RD}$ $\overline{WR}$ $\overline{R}$ $\overline{RD}$ $\overline{A0}$ $\overline{RD}$ $\overline{WR}$ $\overline{R}$ $\overline{RD}$ $\overline{A0}$ $\overline{RD}$ $\overline{WR}$ $\overline{R}$ $\overline{RD}$ $\overline{A0}$ $\overline{E}$ $\overline{R}/\overline{W}$ $\overline{R}$ $\overline{RD}$ $\overline{NR}$ $\overline{R}$ $\overline{R}$ $\overline{RD}$ $\overline{R}$ </td

WR or R/W	Write Control or Read/Write Control. When the 8080 family interface is selected, this signal acts as the active-LOW write strobe. The bus data is latched on the rising edge of this signal. When the 6800 family interface is selected, this signal acts as the read/write control signal. Data is read from the RA8835 series if this signal is HIGH, and written to the RA8835 series if it is LOW.			
CS	output of	-LOW input en	coder devic	A8835 series. It is usually connected to the e that maps the RA8835 series into the processor.
		I/Data Select. Iy Interface:		
	A0	RD	WR	Function
	0	0	1	Status flag read
	1	0	1	Display data and cursor address read
	0	1	0	Display data and parameter write
4.0	1	1	0	Command write
A0	6800 Fami	ly Interface:		
	A0	R/W	E	Function
	0	1	1	Status flag read
	1	1	1	Display data and cursor address read
	0	0	1	Display data and parameter write
	1	0	1	Command write
RES	Schmitt-trig	-LOW input pe gger input for	enhanced n	rdware reset on the RA8835 series. It is a oise immunity; however, care should be if the supply voltage is lowered.

#### 5.1.2 Display Memory Control

The RA8835 series can directly access static RAM and PROM. The designer may use a mixture of these two types of memory to achieve an optimum trade-off between low cost and low power consumption.

Pin Name	Function
VA0 to VA15	<b>16-bit Display Memory Address.</b> When accessing character generator RAM or ROM, VA0 to VA3, reflect the lower 4 bits of the RA8835 row counter.
VD0 to VD7	<b>Display Memory Data Bus.</b> <u>8-bit t</u> ri-state display memory data bus. These pins are enabled when VRD or VWR is LOW.
VWR	Display Memory Write Control. Active-LOW display memory write control output.
VRD	Display Memory Read Control. Active-LOW display memory read control output.



VCE	Display Memory Chip Select.
VOL	Active-LOW static memory standby control signal. $\overline{VCE}$ can be used with $\overline{CS}$ .

#### 5.1.3 LCD Drive Signals

In order to provide effective low-power drive for LCD matrixes, the RA8835 series can directly control both the X- and Y-drivers using an enable chain.

Pin Name	Function
XD0 to XD3	<b>Data Output for Driver.</b> 4-bit X-driver (column drive) data outputs. Connect these outputs to the inputs of the X-driver chips.
XSCL	<b>Latch Clock.</b> The falling edge of XSCL latches the data on XD0 to XD3 into the input shift registers of the X-drivers. To conserve power, this clock halts between LP and the start of the following display line (See section 6.3.7).
XECL	<b>Trigger Clock for Chain Cascade.</b> The falling edge of XECL triggers the enable chain cascade for the X-drivers. Every 16th clock pulse is output to the next X-driver.
LP	Latch Pulse. LP latches the signal in the X-driver shift registers into the output data latches. LP is a falling-edge triggered signal, and pulses once every display line. Connect LP to the Y-driver shift clock on modules.
WF	AC Drive Output. The WF period is selected to be one of two values with SYSTEM SET command.
YSCL	Latch Clock for YD. The falling edge of YSCL latches the data on YD into the input shift registers of the Y-drivers. YSCL is not used with driver ICs which use LP as the Y-driver shift clock.
YD	Data Pulse Output for Y Drivers. It is active during the last line of each frame, and is shifted through the Y drivers one by one (by YSCL), to scan the display's common connections.
YDIS	<b>Power-down Output Signal.</b> YDIS is HIGH while the display drive outputs are active. YDIS goes LOW one or two frames after the sleep command is written to the RA8835 series. All Y- driver outputs are forced to an intermediate level (de-selecting the display segments) to blank the display. In order to implement power-down operation in the LCD unit, the LCD power drive supplies must also be disabled when the display is disabled by YDIS.

#### 5.1.4. Oscillator and Power

Pin Name	Function
XG	<b>Crystal Connection for Internal Oscillator</b> This pin can be driven by an external clock source that satisfies the timing specifications of the EXT f0 signal (See section 7.3.6).
XD	Crystal Connection for Internal Oscillator Leave this pin open when using an external clock source.
VDD	<b>2.7 to 5.5V Supply.</b> This may be the same supply as the controlling microprocessor.



GND	Ground
TEST	Test Pin.
	This is a test pins. No need for connection(NC).

**Note:** The peak supply current drawn by the RA8835 series may be up to ten times the average supply current. The power supply impedance must be kept as low as possible by ensuring that supply lines are sufficiently wide and by placing 0.47µF decoupling capacitors that have good high-frequency response near the device's supply pins.

## 6. System Application

